

0.78

7.30

 \equiv

32X 0.40

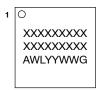
DIMENSIONS: MILLIMETERS

DATE 09 JUL 2015

- NOTES:
 1. DIMENSIONING AND TOLERANCING PER
- DIMENSIONING AND TOLERANGING FER ASME Y14.5M, 1994. CONTROLLING DIMENSION: MILLIMETERS. DIMENSION 6 APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN
- 0.15 AND 0.25MM FROM THE TERMINAL TIP.
 COPLANARITY APPLIES TO THE EXPOSED
 PAD AS WELL AS THE TERMINALS.

	MILLIMETERS		
DIM	MIN	MAX	
Α	0.80	0.90	
A1	0.00	0.05	
А3	0.20 REF		
b	0.25	0.35	
D	7.00 BSC		
D2	4.60	4.80	
Е	7.00 BSC		
E2	4.60	4.80	
е	0.65 BSC		
L	0.45	0.65	
L1	0.00	0.15	

GENERIC MARKING DIAGRAM*



= Assembly Location

WL = Wafer Lot

YY = Year

WW = Work Week = Pb-Free Package

*This information is generic. Please refer

to device data sheet for actual part marking.

Pb-Free indicator, "G" or microdot " ■", may or may not be present.

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DESCRIPTION:	QFN32 7X7, 0.65MM PITCH		PAGE 1 OF 1

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0.65 **PITCH** 5.00

PACKAGE OUTLINE

5.00